Sub-GHz Impedance Matched Balun + LPF integrated Passive Component for Texas Instruments' CC1310 Chipset

P/N: 0850BM14E0016

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Do you need a small 900MHz antenna? Go to: www.johansontechnology.com/antennas

General Specifications			
Part Number	0850BM14E0016		
Frequency (MHz)	770 ~ 860 860 ~ 928		
Unbalanced Impedance (Ω)	50		
Balanced Impedance (Ω)	Impedance matched to Texas Instruments' CC1310 chipset		
Insertion Loss (dB)	1.3 typ (1.6 max.) 1.8 typ (2.2 max		
Return Loss (dB)	9.5 min. 9.5 min.		
Phase Difference (deg)	180±17 180±15		
Amplitude Difference (dB)	3.5 max. 2.0 max.		



Phase Difference (deg)	180±17	180±15	Texas Instruments - Approved!	
Amplitude Difference (dB)	3.5 max. 2.0 max.		Quantity/Reel	4,000 pcs
Attenuation (dB)	15 min.@ 1736~1856MHz 30 min.@ 2310~2580 MHz 30 min.@ 2580~2784 MHz 33 min.@ 3080~3440MHz		Operating Temperature	-40°C to +85°C
			Storage Temperature Range	-40°C to +85°C
			Storage Period	18 months max
			Recommended Storage Conditions for unused	+5 ~ +35 °C, Humidity 45~75%RH, 18 mos.
Power Capacity	2W ma	ax. CW	T&R product	max

For more TI matched balun-filters, go to: www.johansontechnology.com/ti

Part Number Explanation				
P/N Suffix	Packing Style	Bulk	Suffix = S	eg. 0850BM14E0016S
		T&R	Suffix = E	eg. 0850BM14E0016T
		100% Tin	Suffix = None	eg. 0850BM14E0016(T or S)

Me	Mechanical Dimensions				
	ln	mm	<b>A</b>		
L	0.063 ± 0.004	1.60 ± 0.10	■ I W		
W	0.031 ± 0.004	0.80 ± 0.10			
Т	0.024 ± 0.004	0.60 ± 0.10	<del></del>		
а	0.008 ± 0.004	0.20 ± 0.10	a p		
b	0.008 +.004/008	0.20 +0.1/-0.2			
С	0.006 ± 0.004	0.15 ± 0.10	Т		
g	0.012 ± 0.004	0.30 ± 0.10			
р	0.020 ± 0.002	0.50 ± 0.05	1-g-1 1 -1-1 b1-		
	·				

Tei	Terminal Configuration					
No.	Function		No.	Function		
1	Unbal	anced Por	t 4	Balanced Port RF_P		
2	F	RX/TX	•			
3	Balar	nced Port	5	GND		
٦	RF_N		6		GND	
		3	2	1		
		4	5	6		

Would you like us to review your layout for free? Need an antenna recommendation for your application? Contact us at:

www.johansontechnology.com/ask-a-question

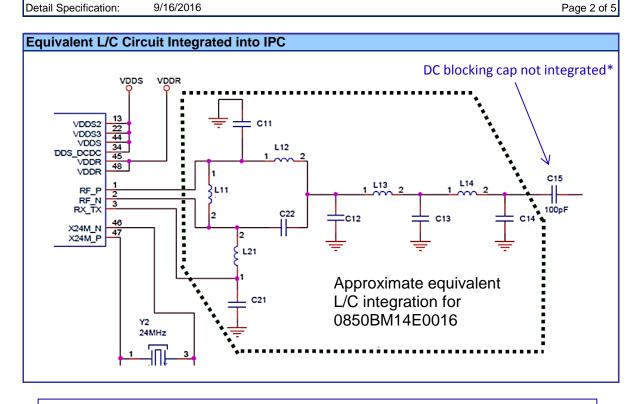
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\*Even though Pins 3, 4, and 1 are internally DC blocked from GND, Pins 3/4 are DC coupled to Pin 1 (there's a DC path between them). We recommend the designer place a DC blocking cap (68-100pF) in series after Pin 1 (between IPC and antenna).

Would you like the reference design, schematic, and gerber files? Need us us to review your layout for free or an antenna recommendation for your application? Contact us at:

www.johansontechnology.com/ask-a-question

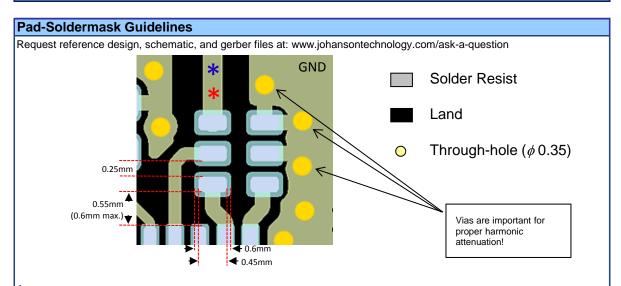
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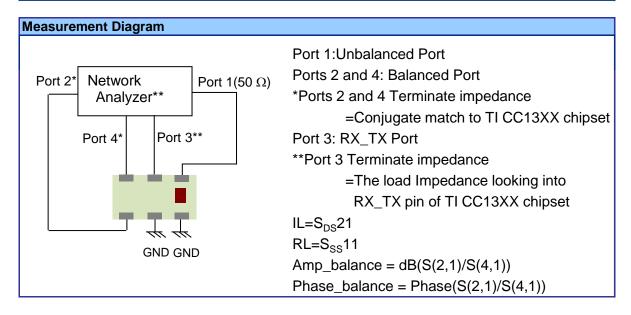
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<sup>\*</sup> Even though Pins 3, 4, and 1 are DC blocked from GND, Pins 3/4 are DC coupled to Pin 1 (there's a DC path between them). We recommend the designer place a DC blocking cap (68-100pF) in series after Pin 1 (between IPC and antenna) per page 2 of the datasheet.

<sup>\*</sup> Line width should be designed to match 50ohm characteristic impedance, depending on PCB material and thickness. Grounded CPWG is recommended.



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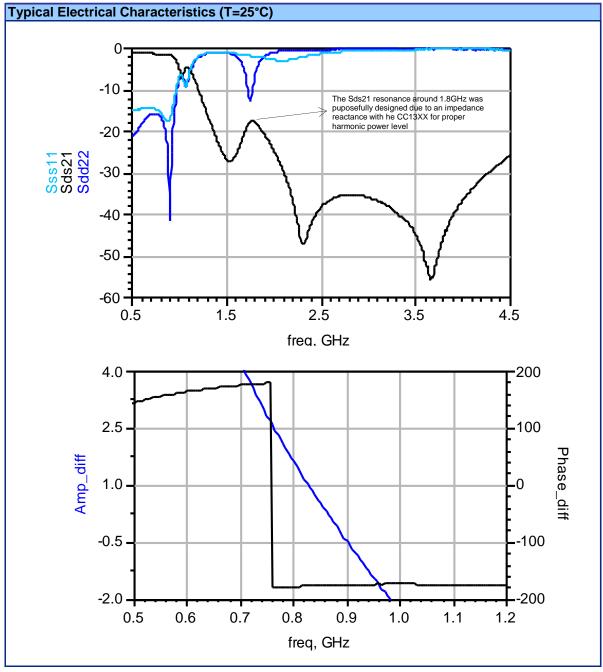
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Application Notes, Layout Files, and more

www.johansontechnology.com/ti

Small SMD 900MHz (or 2.4G, 5G) antennas at:

www.johansontechnology.com/antennas

**RoHS Compliance** 

www.johansontechnology.com/rohs-compliance

Soldering Information

www.johansontechnology.com/ipcsoldering-profile

Antenna layout and tuning techniques

www.johansontechnology.com/tuning

Antenna layout review, tuning, and characterization services

www.johansontechnology.com/ipc-antenna-services

**MSL Info** 

www.johansontechnology.com/msl-rating

Recommended Storage Condition and Max Shelf Life

www.johansontechnology.com/recommended-storage-conditions

**Packaging information** 

www.johansontechnology.com/tape-reel-packaging

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